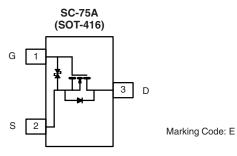


N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS(min.)} (V)	R_{DS(on)} (Ω)	V _{GS(th)} (V)	I _D (mA)			
60	1.25 at V _{GS} = 10 V	1 to 2.5	330			



Ordering Information: Si1022R-T1-E3 (Lead (Pb)-free) Si1022R-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFETs
- Low On-Resistance: 1.25 Ω
- Low Threshold: 2.5 V
- Low Input Capacitance: 30 pF
- Fast Switching Speed: 25 ns
- Low Input and Output Leakage
- Miniature Package
- ESD Protected: 2000 V

APPLICATIONS

- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc.
- Battery Operated Systems
- Solid State Relays

BENEFITS

- Low Offset Voltage
- Low-Voltage Operation
- High-Speed Circuits
- Low Error Voltage
- Small Board Area

Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	60	V	
Gate-Source Voltage		V _{GS}	± 20	v	
Continuous Drain Current ^a	T _A = 25 °C	1-	330		
	T _A = 85 °C	I _D	240	mA	
Pulsed Drain Current ^a		I _{DM}	650		
Power Dissipation ^a	T _A = 25 °C	PD	250	mW	
	T _A = 85 °C	1 D	130	11100	
Thermal Resistance, Maximum Junction-to-Ambienta		R _{thJA}	500	°C/W	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 150	°C	

Notes:

a. Surface Mounted on FR4 board, Power Applied for t \leq 10 s.



COMPLIANT

Si1022R

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static	- <u>-</u>					
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 10 \mu A$	60	1		v
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = 0.25 \text{ mA}$	1		2.5	
Gate-Body Leakage		$V_{DS} = 0 V, V_{GS} = \pm 10 V$			± 150	
	I _{GSS}	T _J = 85 °C			± 500	nA
		$V_{DS} = 0 V, V_{GS} = \pm 5 V$			± 20	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			10	
		T _J = 85 °C			100	
		V _{DS} = 60 V, V _{GS} = 0 V			1	μA
On-State Drain Current ^a	I _{D(on)}	V _{DS} = 10 V, V _{GS} = 4.5 V	500			mA
		V _{DS} = 7.5 V, V _{GS} = 10 V	800			
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$			3.0	
	R _{DS(on)}	T _J = 125 °C			5.0	Ω
		V _{GS} = 10 V, I _D = 500 mA			1.25	
		T _J = 125 °C			2.25	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$	100			mS
Diode Forward Voltage ^a	V _{SD}	V _{GS} = 0 V, I _S = 200 mA			1.3	V
Dynamic ^b	-					
Input Capacitance	C _{iss}			30		pF
Output Capacitance	C _{oss}	V _{DS} = 25 V, V _{GS} = 0 V, f = 1 MHz		6		nC
Reverse Transfer Capacitance	C _{rss}			2.5		
Gate Charge	Qg	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 250 \text{ mA}, \text{ V}_{GS} = 4.5 \text{ V}$			0.6	
Switching ^{b, c}				•	•	
Turn-On Time	t _(on)	V_{DD} = 30 V, R _L = 150 Ω, I _D = 200 mA, V _{GEN} = 10 V, R _G = 10 Ω		25		
Turn-Off Time	t _(off)				35	ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

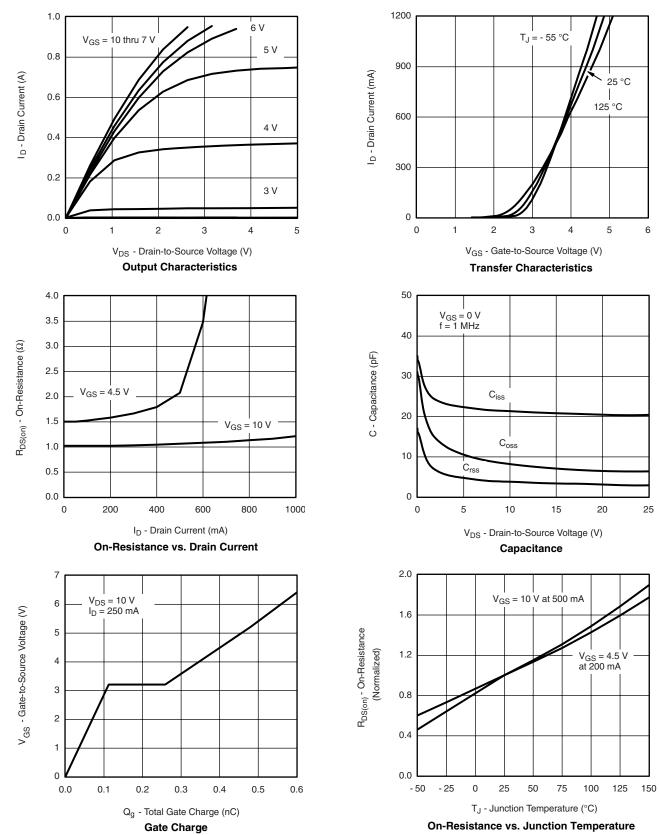
b. For DESIGN AID ONLY, not subject to production testing.

c. Switching time is essentially independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



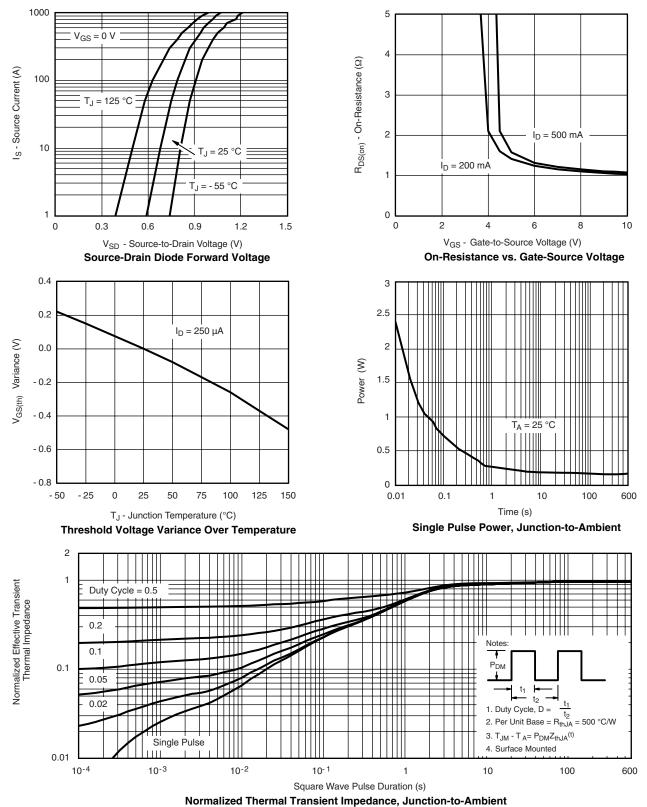




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TYPICAL CHARACTERISTICS $T_A = 25 \text{ °C}$, unless otherwise noted



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